

Title (en)  
LAMINATE AND MANUFACTURING METHOD FOR SAME

Title (de)  
LAMINAT UND HERSTELLUNGSVERFAHREN DAFÜR

Title (fr)  
STRATIFIÉ ET SON PROCÉDÉ DE FABRICATION

Publication  
**EP 3306362 B1 20211103 (EN)**

Application  
**EP 16802825 A 20160602**

Priority  
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Abstract (en)  
[origin: EP3306362A1] This invention aims to provide a novel laminate in which a first layer is formed with high positional accuracy, and to provide a manufacturing method thereof. In the laminate of this invention, a relief structure forming layer includes a first region having an indented structure extending in a first direction or a direction tilted by an angle within 10 degrees to the left or right from the first direction in a plan view, and a second region including an indented structure extending in a second direction orthogonal to the first direction or a direction tilted by an angle within 65 degrees to the left or right from the second direction in a plan view. The first layer contains a first material which is different from a material of the relief structure forming layer, and has a surface shape corresponding to that of the relief structure forming layer.

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Citation (opposition)  
Opponent : Giesecke+Devrient Currency Technology GmbH  
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